

APPLICATION FOR UNITED STATES PATENT
Declaration for Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on

the invention entitled: RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A METHOD OF MANUFACTURING THE SAME

the specification of which (check at least one) 2 (file no. JEL 30763 PCT)

- 3 ☐ is attached hereto
4 ☒ was filed on August 31, 1999 as (5) U.S. Application Serial No. 09/380,312
6 ☐ and was amended on _____ (if applicable)

Use this portion only if you are entering the U.S. National phase based on a PCT International Application designating the U.S.	7 <input checked="" type="checkbox"/>	was filed as PCT international application
	8	Number <u>PCT/JP98/02544</u>
	9	on <u>June 8, 1998</u>
	10	and was amended under PCT Article(s) 19 and/or 34 on _____ (if applicable).
	11	priority date claimed in PCT International Application (earliest) <u>JAPAN</u> <u>09-171395</u> <u>27.06.97</u> (Country) (Number) (Day/Month/Year Filed)

I hereby declare that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended, by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me which is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date earlier than that of the application(s) on which priority is claimed.

Prior (Foreign) Application(s) any Priority Claims Under 35 U.S.C. 119 Priority Claimed

12a	<u>JAPAN</u> (Country)	<u>9-171395</u> (Number)	<u>June 27, 1997</u> (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
	<u>JAPAN</u> (Country)	<u>10-73711</u> (Number)	<u>March 23, 1998</u> (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No

Priority Claim(s) from U.S. Provisional Application(s) - I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

Application No.	Day/Month/Year Filed	Application No.	Day/Month/Year Filed
Do not use this portion to identify a PCT application if the parent application is the U.S. National phase of the PCT application			
I hereby claim the benefit under Title 35, United States Code, 120 of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between filing date of the prior application and the national or PCT international filing date of this application.			
13	<u> </u> (U.S. Application Number)	<u> </u> (U.S. Filing Date)	<u> </u> Status (patented, pending, abandoned)

I hereby appoint the following attorneys of the firm of Stevens, Davis, Miller & Mosher, L.L.P. as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent and Trademark Office:

James E. Ledbetter, Reg. No. 28732; Thomas P. Pavelko, Reg. No. 31689; and Anthony P. Venturino, Reg. No. 31674.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO STEVENS, DAVIS, MILLER & MOSHER, L.L.P., 1615 L Street, N.W., Suite 850, Washington, D.C. 20036, TELEPHONE (202) 463-5100, FACSIMILE (202) 463-5200.

See page 2 for signature lines

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful statements may jeopardize the validity of the application or any patent issuing thereon.

PAGE 2 OF U.S.A. DECLARATION FORM

14a	Typewritten Full Name of Sole or First Inventor	<u>Masanori MINAMIO</u>		
		Given Name	Middle Name	Family Name
15a	Inventor's Signature	<u>Masanori Minamio</u>		
16a	Date of Signature	<u>September 30, 1999</u>		
		Month	Day	Year
17a	Residence	<u>Osaka</u>	<u>JAPAN</u>	
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14b	Typewritten Full Name of Sole or Second Inventor	<u>Satoru KONISHI</u>		
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16b	Date of Signature	<u>September 30, 1999</u>		
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14c	Typewritten Full Name of Sole or Third Inventor	<u>Yoshihiko MORISHITA</u>		
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14d	Typewritten Full Name of Sole or Fourth Inventor	<u>Yuichiro YAMADA</u>		
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*Note to Inventor: Please sign name on line 15 exactly as it appears in line 14 and insert the actual date of signing on line 16. If there are more than four inventors, please add a copy of this page for identification and signatures for the additional inventors.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believe to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful statements may jeopardize the validity of the application or any patent issuing thereon.

PAGE 3 OF U.S.A. DECLARATION FORM

14e	Typewritten Full Name of Sole or First Inventor	<u>Fumito ITOH</u>		
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15e	Inventor's Signature	<u>Fumito Itoh</u>		
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16f	Date of Signature			
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17f	Residence			
		City	State or Province	Country
18f	Citizenship			
19f	Post Office Address (Insert complete mailing address, including country)			
14g	Typewritten Full Name of Sole or Third Inventor			
		Given Name	Middle Name	Family Name
15g	Inventor's Signature			
16g	Date of Signature			
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17g	Residence			
		City	State or Province	Country
18g	Citizenship			
19g	Post Office Address (Insert complete mailing address, including country)			
14h	Typewritten Full Name of Sole or Fourth Inventor			
		Given Name	Middle Name	Family Name
15h	Inventor's Signature			
16h	Date of Signature			
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17h	Residence			
		City	State or Province	Country
18h	Citizenship			
19h	Post Office Address (Insert complete mailing address, including country)			

*Note to Inventor: Please sign name on line 15 exactly as it appears in line 14 and insert the actual date of signing on line 16. If there are more than four inventors, please add a copy of this page for identification and signatures for the additional inventors.

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